



Product Change Notification

Change Notification #: **116083 - 01**
Change Title: **Intel® TPM Module AXXT PME6, PCN 116083-01, Product Design, Firmware update, Reason for Revision: TA# Updated**
Date of Publication: **February 20, 2018**

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	February 27, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: TA# Updated

Intel is updating the reference code of the Intel® Server Accessory AXXT PME6 from 5.61 to 5.62. This reference code is part of the firmware version 2.0 that the TPM6 has embedded.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre TA#	Post TA#
AXXT PME6	947921	H97486-003	H97486-004

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
February 12, 2018	00	Originally Published PCN
February 20, 2018	01	TA# Updated



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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